

Request for Participation (RFP) — submission deadline May 31, 2015

Introduction/Overview

In 2015, SEMICON Europa will feature an enhanced INNOVATION VILLAGE (IV) with the focus on connecting early-stage companies with strategic investors, venture capitalists and other relevant stakeholders for the second time. Additionally, *HighTech Startbahn* will bring their esteemed Investors Congress “HIGHTECH VENTURE DAYS” (HTVD) to SEMICON Europa as well. In this way, the two partners SEMI & HighTech Startbahn combine their proven concepts in a 4-day-event by providing start-ups and growth companies a tailored way to strengthen their visibility.

With 40 private pitches (to investors only) at HTVD and 20 public pitches (to investors, exhibitors & attendees) in the IV, focusing on ICT, Micro- and Nanotechnology, Materials Science, Environment and Energy Technology, Machinery and Plant Engineering, Life Science and Automotive INNOVATION VILLAGE & HIGHTECH VENTURE DAYS will cover all the various aspects and needs of high-tech ventures and investors.

Our recipe: 40+20 selected companies, 6 high-tech areas, up to 10 minute pitches and 60+ investors!

Our Offer	Pitch @ INNOVATION VILLAGE (20 selected companies)	Pitch @ HIGHTECH VENTURE DAYS (40 selected companies)	Pitch @ both formats
Tool / Match Making	X	X	X
Pitchtraining	X	X	X
Review Onepager	X	X	X
Pitch/Presentation	@ INNOVATION VILLAGE	@ HIGHTECH VENTURE DAYS	@ both formats
HTVD Evening Event (5th Oct.)	X	X	X
Poster @INNOVATION VILLAGE (200x100 cm)	X	X	X
Exhibition kiosk @INNOVATION VILLAGE	X		X
entry in the list of exhibitors	X		X
Price:Start-up(Member*)+19%VAT	519,00 € (419,00 €)	119,00 € (99,00 €)	639,00 € (509,00 €)
Price:Growth company(Member*)+19%VAT	699,00 € (559,00 €)	199,00 € (159,00 €)	899,00 € (719,00 €)

*) SEMI or/and HighTech Startbahn Netzwerk e.V.

How to Participate

To be considered for this opportunity, you must submit a completed application form. This will give our Silicon Innovation Forum (SIF) committee & HighTech Startbahn an idea of the activity and profile of your company/innovation team. The SIF Committee (IV) and HighTech Startbahn (HTVD) will then review the applications and invite a certain number of applicants to participate in IV and/or HTVD.

Key Dates

5/31/2015 Deadline for RFP Applications
6/15/2015 Final approval of Participants (40x HIGHTECH VENTURE DAYS & 20x INNOVATION VILLAGE)

Company Information

Company		start-up (less than 5 years since founding)
Contact	Title	growth company (more than 5 years since founding)
Surname	Pitch @	IV HTVD both
Name	Membership	SEMI HighTech Startbahn no Member
Web (URL)	VAT No.	
Street Address	City	
State/Province	Country	
Email	Phone	
Date	Signature	

Please send the completed form to the following addresses:

call@hightech-venture-days.com
semicon.europa@semi.org

Company Name



Pitch @ HIGHTECH VENTURE DAYS

INNOVATION VILLAGE

Business Sectors (tick all that apply)

Company Information

- Machinery and Plant Engineering
- Micro- and Nanotechnology & ICT
- Life Science
- Materials Science
- Automotive Industry
- Environment and Energy Technology

- Years in Business
- Number of Employees
- IP associated with technology
- Active Customer Base

Stage of Development

Problem

Financial Needs

Solution

Applications

Technology

Investment opportunity

Business Model

Market

Competition

Contact:

Name

Phone

Email

Web URL